

Manufacturer: **Epoxy Technology** 

# **Product Name:**

EPO-TEK® 353ND High Temperature Epoxy, Heat Cure - Pre-Mixed and Frozen (3cc Syringe)

**Manufacturer Part Number:** ET353ND-3CC

Click here for more details on the EPO-TEK® 353ND High Temperature Epoxy, Heat Cure - Pre-Mixed and Frozen (3cc Syringe)



### **EPO-TEK® 353ND Technical Data Sheet** For Reference Only High Temperature Epoxy

Date: Rev:	March 2023 XXXI			Recommended Cure: 150°C / 1 Hour			
No. of Components: Mix Ratio by Weight: Specific Gravity: Pot Life: Shelf Life- Bulk: Shelf Life- Syringe: NOTES:	Two 10 : 1 Part A: 1.20 ≤ 3 Hours One year at room Six months at -40°		<b>Syringe</b> : 1.18 <b>Syringe</b> : ≤ 2 Hours			Minimum Alternative Cure(s): May not achieve performance properties below 150°C / 1 Minute 120°C / 5 Minutes 100°C / 10 Minutes 80°C / 30 Minutes	
<ul> <li>Folles.</li> <li>Container(s) should be kept closed when not in use.</li> <li>Filled systems should be stirred thoroughly before mixing and prior to use.</li> <li>Performance properties (rheology, conductivity, others) of the product may vary from those stated on the data sheet when bi-pak/syringe packaging or post-processing of any kind is performed. Epoxy's warranties shall not apply to any products that have been reprocessed or repackaged from Epoxy's delivered status/container into any other containers of any kind, including but not limited to syringes, bi-paks, cartridges, pouches, tubes, capsules, films or other packaging.</li> <li>Syringe packaging will impact initial viscosity and effective pot life, potentially beyond stated parameters.</li> <li>If product crystalizes in storage, place container in warm oven until crystallization disappears.</li> <li>TOTAL MASS SHOULD NOT EXCEED 25 GRAMS</li> <li>Product Description: EPO-TEK® 353ND is a two component, high temperature epoxy designed for semiconductor, hybrid, fiber optic, and medical</li> </ul>							
applications. It is one of the most popular EPO-TEK® brand products, and is known throughout the world for its performance and reliability. Also							
available in single component frozen syringe. Typical Properties: Cure condition: 150°C / 1 Hour Different batches, conditions & applications yield differing results.							
Date below is not guaranteed. To be used as a guide only, not as a specification. * denotes test on lot acceptance basis							
PHYSICAL PROPERTIE	S:						
* Color (before cure):		Part A: Clear		er < 5)	Part B: A	mber (Gardner < 18)	
* Consistency: * Viscosity (23°C) @ 50 r	mm.	Pourable liqu	. 5,000	cPs			
Thixotropic Index:	pin.	5,000	N/A	013			
* Glass Transition Temp: Coefficient of Thermal Expansion (CTE):			≥ 90 °C (Dynamic Cure: 2		amic Cure: 2	0-200°C/ISO 25 Min; Ramp -10-200°C @20°C/Min)	
	Below Ta:		54	x 10 <sup>-6</sup> i	n/in°C		
	Above Tg:		206	x 10 <sup>-6</sup> i			
Shore D Hardness:	0		85				
Lap Shear @ 23°C:		>	2,000	psi			
Die Shear @ 23°C:			≥ 15		5,334 psi		
Degradation Temp:			412	°C			
Weight Loss:	@ 200°C:		0.22	%			
	@ 250°C:		0.39	%			
	@ 300°C:		0.87	%			
	uggested Operating Temperature:		< 350	°C (Intermittent)			
Storage Modulus:			08,298	psi			
Ion Content:			9 ppm	K⁺:	Ennm		
* Particle Size:		N⊓4. 40	9 ppm N/A	Γ.	5 ppm		
ELECTRICAL AND THERMAL PROPERTIES:							
Thermal Conductivity:			N/A				
Volume Resistivity @ 2							
Dielectric Constant (1KHz):		3.17					
Dissipation Factor (1KH			0.005				
OPTICAL PROPERTIES @ Spectral Transmission:	23.0:	> 50%	@ 550	nm			
		≥ 95% @ 110		nm			
		≥ 98% @ 80		nm			
Refractive Index (uncured)		1.5694	4 @589	nm			

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# Contact the professionals at Fiber Optic Center for a quote or to get more details.

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# EPO-TEK<sup>®</sup> 353ND Advantages & Suggested Application Notes:

- Reasonable pot-life that allows for low temperature curing to be realized. It has an amber color change upon cure.
- Passes NASA low outgassing standard ASTM E595 with proper cure http://outgassing.nasa.gov/
- Semiconductor suggested applications: wafer-wafer bonding of CSP; fabrication of MEMs devices; flip chip underfill.
- Hybrid suggested applications: providing near hermetic seals and UHV seals in sensor devices, resisting high temperature packaging.
  - Down-Hole petrochemical fiber optic sensors, resisting >200°C field conditions.
- Fiber optic adhesive designed to meet Telecordia 1221 suggested applications:
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  - Sealing fiber into ferrules, transmitting light in the optical pathway from 800- 1550 nm range.
  - Fiber component packaging; adhesive for active alignment of optics, environmental seal of opto-package, V-groove arrays.
- Electronics Assembly suggested applications:
  - Used as dielectric layer in the fabrication of capacitors; laminating PZT ferroelectrics found in ultrasound or ink-jetting devices.
  - Impregnating and insulating copper coil windings in motors and inductor coils. Bonding ferrite cores and magnets.
  - Structural grade epoxy found in hard-disk drive devices; bonding of SST metals, kapton, and magnets.

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